A Study of the Process

of
Electrical Conduction

in
Films of India Ink

A thesis presented to the Department of Chemistry of Union College in partial fulfillment of the requirements for the Degree of Bachelor of Science in Chemistry by

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May 20, 1925.

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UN92 L651 1925

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INTRODUCTION

The grid leak used in radio engineering often is an ink film. It is used as a path of escape of electrons from the grid. This path is necessary, for electrons collect on the grid and cause it to become negatively charged. Since a vacuum tube will not function unless the grid is charged positively with respect to the filiament, the necessity of the grid leak is obvious. The rate of absorbtion of electrons by the grid, and of their removal by the grid leak can be controlled to a certain extent by varying this grid leak resistance. Figure 1 shows the use of the grid leak (R) in a wireless receiving set. The commercial India Ink grid leaks are made of a sheet of cardboard about an eighth of an inch wide and an inch long, covered on both sides with India Ink which serves as the conductor.

Although the exact constituents and the method of manufacture of India Ink are business secrets, we know that India Ink is a colloidal suspension of small particles of carbon and liquid glue called size.

In this work I tried to determine three things. First, whether or not this ink colloid showed Kataphoresis. Second, the effect of moisture on the resistance. Third, whether the conductivity of the ink film was metallic or edectrolytic.

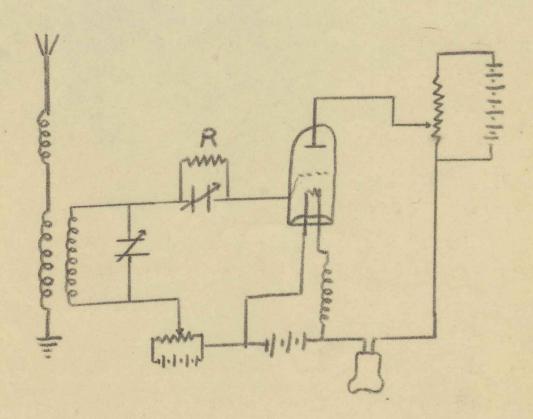


Fig. 1

APPARATUS

To test for kataphoresis, I used a U tube with side arms and copper wires for electrodes as is shown in Figure 2. I used a solution containing 5cc of ink in 50cc of solution, and a potential difference of 6 volts from a storage battery.

To find the effect of dilution on the resistance of solutions of ink in water, I used a conductivity cell and a Wheatstone bridge. Of course in measuring the resistance of solutions I had to use high frequency alternating current and telephone receivers. I used a variable condenser to balance the capacity of the conductivity. cell. Figure 3 shows the conductivity cell, with the long and short distances between the electrodes. Figure 4 shows the wiring diagram used for this work, Thowing the oscillating circuit I used as a source of high frequency alternating current, and the Wheatstone bridge, where r, r, and R are variable and Xis the resistance to be measured.

To determine the effect of humidity on the resistance of the nk films, I placed some grid leaks, which I made, in desiccators ontaining different salts, whose aqueous vapor tension was available from tables. I measured the resistance withthe same Wheat-tone bridge arrangement as is shown in Figure 4. Later I found that I could use direct current and agalvanometer instead of alterating current and telephones. Since this increased the accuracy of my measurements, I made this replacement. Figure 5 shows the

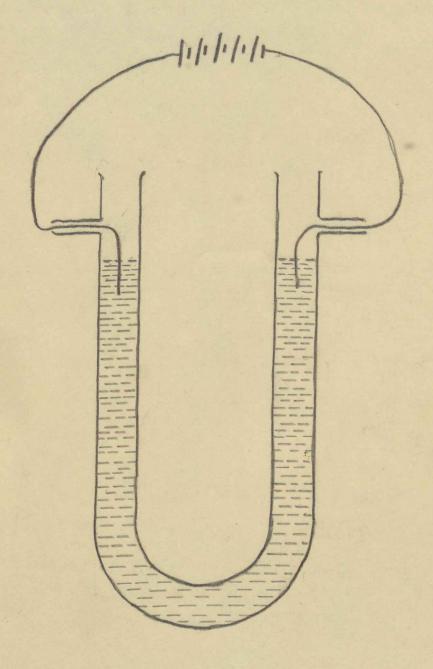


Fig. 2

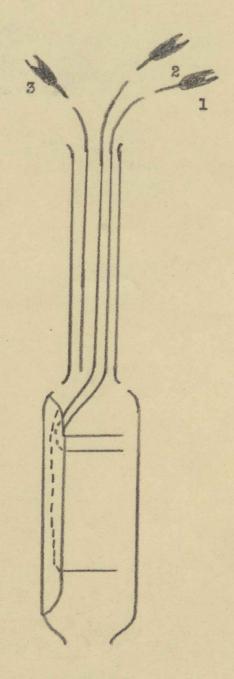


Fig. 3

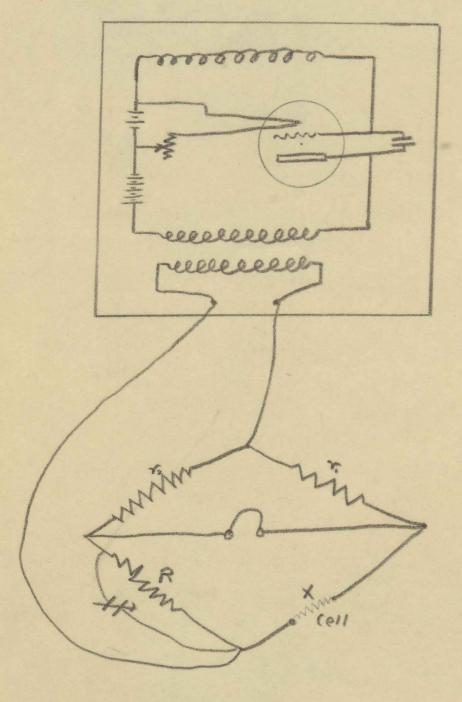


Fig. 4

type of desiccator fitted with wires which I used.

To find whether the conduction was metallic or electrolytic I used desiccators such as shown in Figure 5 and measured resistances with the Wheatstone bridge of Figure 4 using dirrect current and galvanometer. As a source of current through the grid leak I used a D.C. generator.

RESULTS

I kept a potential difference of six volts between the electrodes as shown in Figure 2 for seventy hours. During this time
most of the carbon moved into the space about the anode leaving
the rest of the solution transparent, but dark brown in color.

Measuring the resistance of solutions containing various proportions of ink and water I obtained the comparative results of tables1. These results are plotted in the curves of Figures 6 and 7.

TABLE I

ec of ink in	Resistance		
100cc of solution	short space	long space	
.0625 .1250 .2500	4,950 3,700 2,300	46,300 ohms 32,000 " 21,600 "	
.5000 1.0000 2.0000	1,320 810 460	12,100 " 7,400 " 4,300 "	
3.0000 4.0000	297 190 130	2,850 " 1,600 " 1,100 "	
5.0000 6.6666 8.3333	114	1,070 "	

In studying the effect of humidity on the resistance of knk films in the form of grid leaks, I placed some of them in desiccators containing anhydrous calcium chloride and measured thechange in resistance as they were dried out. Believing that the card board was not

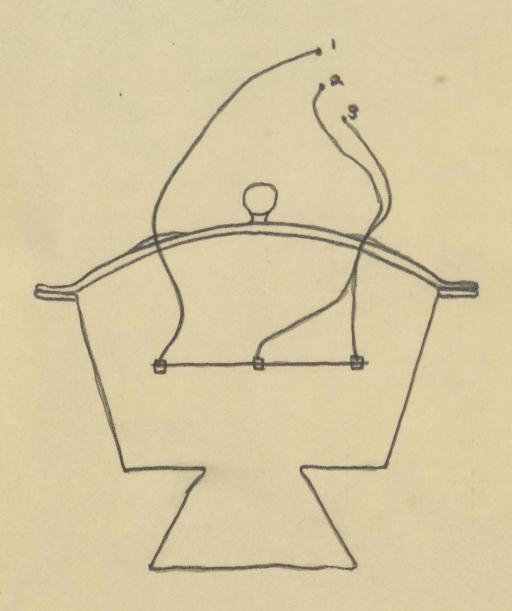


Fig. 5

rigid enough. I made some by coating with India Ink some microscope slides whose surfaces had been roughened with hydrofluoric acid. These I subjected to the above treatment also. These results are shown in Table 2. Also I took a grid leak which had been dried out with calcium chlotide and put it over hydrated copper sulphate which gives a pressure of water vapor over it of 7mm. The changes of resistance are shown in Table 3.

TABLE 2

0 4 1 hr 1 18hrs 2 24hrs 3 30hrs 3	asing cardboard) esistance :10,000 ohms :60,000 " :00,000 " :000,000 " :000,000 "	Run 2 Time O 2 days 3 days 4 days 5 days 6 days 7 days 9 days	(using glamater Resistant 370,000 1200,000 1300,000 1400,000 1400,000 1500,000	ce
O 1 hr 3 2 hrs 4 1 day 4 5 days 4 8 days 4	sing glass) Resistance 50,000 ohms 29,000 " 00,000 " 00,000 " 00,000 " 00,000 "	Run 4 Time O 1 hr 2 hrs 3 hrs 4 hrs 2 days 2 days 10days	(using glas Resistant 280,000 310,000 280,000 320,000 160,000 250,000 160,000	е

TABLE 3

Time Resistance 0 201,000 ohi 3 hrs 238,000 " 1 day 240,000 " 4 days 300,000 " 8 days 255,000 " 10days 256,000 " 19days 275,000 "	Passe II assissator)
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To determine whether the conduction was metallic or electrolytic I placed a grid leak in the desiccator shown in Figure 5 uning hydrated copper sulphate and passed a direct current through it from 1 to 3. Table 4 shows some of my results.

TABLE 4

Time		Run 1 (Or Resist	ver Copper Sul	lphate)	
0	1-3 240,000 275,000	1-2 117,000 138,000	2-3 120,000 133,000	Ratio 1-2/2-3 .975 1.038	3
Time		Run 2 (0ve	er Anhydrous (Calcium Chloride	1
0 19 days	1-3 200,000 200,000	1-2 98,000 100,000	2-3 100,700 100,000	.978 1.000	
		CONCLUSIONS			

For the first, the ink solution shows kataphoresis, and the results prove that the carbon particles have a negative dharge in this colloid.

Since the resistance of the ink solutions increased with dilution, it must be that it is the carbon particles which carry the current, and not the supporting colloid.

My results on the effect of humidity on the resistance of grid leaks are not definite enough to draw any conclusions from.

The ratio of the resistance of the part of the grid leak on the positive side to the resistance of the parton the negative side is slightly larger after the current has been passed through it. However, this change is not large enough to lead to the belief that the carbon particles carry the current by passing from the positive to the negative terminal, that is, electrolytic conduction, or rather kataphoresis. Since this charge is very small, however, I am led to believe that the conduction is, for the most part, metallic.

